



Wire-to-Board Shielded Horizontal 4 Position Board Mount H Code 2 mm (.08 in) Centerline Signal Automotive HSD Data Connectivity Headers

Part Number:

TE-1-1823071-2

| Basic Information | |
|--------------------------|--------------------------|
| Number of Positions | 4 manufact manufact man |
| Series | HSD |
| Tcpn | 1-1823071-2 |
| Product Description | HSD,HDR ASSY,90DEG,COD H |
| Mixed & Hybrid Connector | No |
| Connector System | Wire-to-Board |
| Number of Rows | 2 PREMIUTUS. |
| PCB Mount Orientation | Horizontal |
| Keying Code | н |
| Contact Type | Pin Massacrec |
| Center Contact | With |
| Connector Mounting Type | Board Mount |

| Mechanical Specification | | mediacries. | |
|--------------------------|--------------------|-------------|----------|
| Mating Pin Diameter | .6 mm (.02 in) | / | <u> </u> |
| Centerline (Pitch) | 2 mm (.08 in) | | |
| Connector Height | 14.2 mm (.559 in) | | |
| Product Length | 27.4 mm (1.079 in) | | |
| Product Width | 12 mm (.472 in) | | |
| PCB Mount Retention Type | Boardlock | | |
| Panel Attachment Style | Rear Mount | | |



| Material Specification | | |
|----------------------------------|-----------|--|
| Contact Mating Plating | Gold (Au) | |
| Connector Center Contact Plating | Gold (Au) | |
| Housing Color | Violet | |
| Body Material | PBT GF | |
| PCB Retention Plating | Tin | |

| Electrical Specification | |
|-----------------------------------|-----------------------|
| Connector & Contact Terminates To | Printed Circuit Board |
| Contact Current Rating (Max) (A) | 2.5 |
| Termination Method to PCB | Through Hole - Solder |
| Mating Retention | With |
| PCB Mount Retention | With |
| Impedance (Ω) | 100.0 |

| Environmental Specification | |
|-----------------------------|-----------------------------|
| Sealable | No |
| Operating Temperature (Max) | 105 °C (221 °F) |
| Operating Temperature Range | -40 - 105 °C (-40 - 221 °F) |

Disclaimer

The information in this specification is subject to change without notice. Please confirm the latest version before use. Technical parameters are for reference only, and sufficient testing and verification should be conducted in actual applications.